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- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input and Output Levels
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

description

The SN74CBTS16211 provides 24 bits of high-speed TTL-compatible bus switching with Schottky diodes on the I/Os to clamp undershoot. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device can operate as a dual 12-bit bus switch or a single 24-bit bus switch. When $1\overline{OE}$ is low, 1A is connected to 1B. When $2\overline{OE}$ is low, 2A is connected to 2B.

The SN74CBTS16211 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each 12-bit bus switch)

INPUT OE	FUNCTION			
L	A port = B port			
Н	Disconnect			

DGG, DGV, OR DL PACKAGE (TOP VIEW)

		U		
NC [1		56	10E
1A1 [2		55	20E
1A2 🛚	3		54] 1B1
1A3 [4		53] 1B2
1A4 [5		52] 1B3
1A5 [6		51] 1B4
1A6 🛚	7		50] 1B5
GND [8		49	GND
1A7 🛚	9		48] 1B6
1A8 [10		47] 1B7
1A9 🛚	11		46] 1B8
1A10 [12		45] 1B9
1A11 [13		44] 1B10
1A12 [14		43] 1B11
2A1 [15		42] 1B12
2A2 🛚	16		41	2B1
v _{cc} [17		40	2B2
2A3 [18		39	2B3
GND [19		38	GND
2A4 [20		37	2B4
2A5	21		36	2B5
2A6	22		35	2B6
2A7 [23		34	2B7
2A8 🛚	24		33	2B8
2A9	25		32	2B9
2A10	26		31	2B10
2A11 [27		30	2B11
2A12 [28		29	2B12

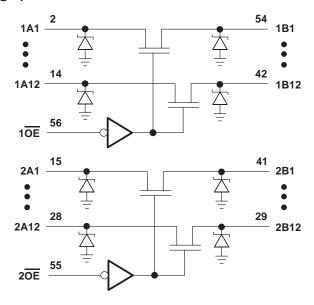
NC - No internal connection



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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		. -0.5 V to 7 V
Input voltage range, V _I (see Note 1)		. -0.5 V to 7 V
Continuous channel current		128 mA
Input clamp current, I_{IK} ($V_I < 0$)		−50 mA
Package thermal impedance, θ_{JA} (see Note 2):	DGG package	81°C/W
•	DGV package	86°C/W
	DL package	74°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
V _{IL}	Low-level control input voltage		0.8	V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT			
VIK		$V_{CC} = 4.5 \text{ V},$	I _I = -18 mA				-1.2	V
ļ.,	Iլլ	$V_{CC} = 5.5 \text{ V},$	V _I = GND				-1	μΑ
†į	lін	$V_{CC} = 5.5 \text{ V},$	V _I = 5.5 V				150	μΑ
ICC		$V_{CC} = 5.5 \text{ V},$	$I_{O} = 0$,	$V_I = V_{CC}$ or GND			3	μΑ
∆lcc [‡]	Control inputs	$V_{CC} = 5.5 \text{ V},$	One input at 3.4 V,	Other inputs at V _{CC} or GND			2.5	mA
Ci	Control inputs	V _I = 3 V or 0				3		pF
C _{io(OFF)}		$V_0 = 3 \text{ V or } 0,$	OE = V _{CC}			5.5		pF
r _{on} §		$V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$	V _I = 2.4 V,	I _I = 15 mA		14	20	
			V 0	I _I = 64 mA		5	7	Ω
		$V_{CC} = 4.5 \text{ V}$ $V_{I} = 0$	I _I = 30 mA		5	7		
		V _I = 2.4 V,	V _I = 2.4 V,	I _I = 15 mA		8	12	

[†] All typical values are at V_{CC} = 5 V (unless otherwise noted), T_A = 25°C.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4 V		V _{CC} = 5 V ± 0.5 V		UNIT
			MIN	MAX	MIN	MAX	
$t_{pd}\P$	A or B	B or A		0.35		0.25	ns
t _{en}	ŌĒ	A or B		9.3	3.3	8.6	ns
t _{dis}	ŌĒ	A or B		7.1	2.8	7.9	ns

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

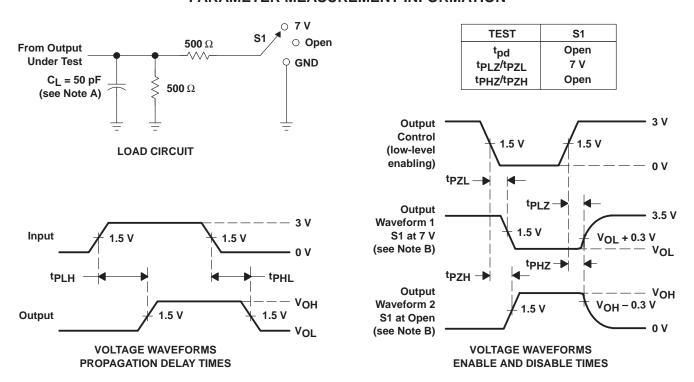


[‡] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

[§] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{\Omega} = 50 \Omega$, $t_r \leq 2.5 \text{ ns.}$
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpZL and tpZH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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